Neutronics, Inc. EXPERTS IN OXYGEN ANALYSIS AND CONTROL

Your Local Area Ntron Sales Rep is:



Process Oxygen Application Worksheet

Page 1 of 3

Contact/Project Inform	nation	Name of Person Completin	3			
Name/ Title:	Alternate Contact ¹ :					
Phone:	Alternate Phone:					
E-mail:		Alternate E-mail:				
Company:		Co	mpany Divisi	on:		
Address:						
City:			Sta	te:	Zip:	
Project ID:						
Project Location:						
Application Descriptio	n:					
	I					
Vessel ID:						
the proper Sample Co	<i>on</i> Note: Pl onditioning Sys	lease fill out this section stem for your application	as complete	ely as possible cs respects th	e to al ne cor	low us to specify ifidentiality of all
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(*SEE REVERSE SIDE of P.2 FOR QUESTIONNAIRE FOOTNOTES)

Rev. 1 07/08

Page 2 of 3

Area Electrical Ratings Information

Electrical Rating at Vessel Site		Electrical Rating Where Analyzer will be Mounted		
Class		Class		
Division		Division		
Group	□ B □ C, D □ E, F, G	Group	□ B □ C, D □ E, F, G	
	□ Non-Hazardous		□ Non-Hazardous	
	□ Not sure, Please call me to Discuss		□ Not sure, Please call me to Discuss	

Compatible Materials	Available Utilities (Specify at Vessel and/or Control Room)
□ Stainless Steel (Type):	Electric: 🗆 110 V 🛛 220 V 🗆 Other
□ Teflon	Compressed Air: PSIG
Other (Please List Below)	Inert Gas: $\Box N_2$ $\Box CO_2$ \Box OtherPSIG
	Cooling Water Temp (°F / °C)

Analyzer/Electronics Information: This section allows us to specify the appropriate analyzer, enclosures, alarms, outputs, etc., for your application. Please fill out this section as completely as possible, and check all items that apply. We will provide you a sketch of our recommended system layout showing all of the Sample Conditioning and Electronic components necessary for your application.

General	
Oxygen Analysis Range:	Analyzer Signal Requirements:
□ 0 to 10%	Monitor Oxygen Levels Only
□ 0 to 25%	Monitor & Automatically Control Oxygen Levels (Stand-Alone)
□ 0 to 100%	□ Monitor & Output Signal to Existing Plant Control System
□ 0 to 1000 PPM	(PLC, Control Room DCS, etc.)
□ 0.1 PPM to 100%	□ Other (Please call me to Discuss)
□ PPB to 100%	
□ Not Sure (Call me to Discuss)	

Aları

Alarm/Output Requirements	Relay contacts (List Se	et Points Required)
4-20 mA Output only, no relays required	Alarm #1	% O ₂
4-20 mA Output with alarms listed at right	Alarm #2	% O ₂
Not sure, please call me to discuss	Alarm #3	% O ₂
	Alarm #4	% O ₂

Analyzer Enclosure Requirements Check only what applies to your application)

If installing in a Non-Hazardous area, I prefer...

□ Flush Mount Analyzer to an Existing Panel

U Wall Mount Nema 4

- If installing in a Class I, II or III Area, I prefer:
- NEMA 7, Explosion Proof Enclosure
 - NEMA 4, Z-Purge Cabinet

Rack Mount Analyzers into a common enclosure multiple Analyzer Installations only.... 3, 6 & 15 channel systems available)

Neutronics, Inc.

EXPERTS IN OXYGEN ANALYSIS AND CONTROL

APPLICATION DATA QUESTIONNAIRE FOOTNOTES:



Page 3 of 3

Notes to Sales Reps:

Foot Note No.	
1	It is important to get an Alternate Contact name, title, phone and e-mail address. After application data questionnaires are received at Neutronics, Inc. it is often necessary to follow-up for additional information before a quote can be generated. If Primary Contact is unavailable, the quote generation process can be delayed. Alternate Contact should be familiar with the project and able to answer
	pertinent process and performance requirements questions when the Primary Contact is unavailable.
	I ry to obtain cell phone numbers in addition to office phone numbers, whenever possible.
2	Is the customer replacing a flow meter, blanketing valve or some other measured volume inerting method with an oxygen based sensor/analyzer method? If so, provide details in Comments area below.
3	It is VERY important to determine what pressure and temperature conditions exist AT THE SAMPLING POINT LOCATION both during sample extraction and when sampling is not taking place. Some processes do not require sampling at different stages of the process cycle, therefore it is also important to determine what extreme pressure and temperature conditions may exist at the sampling location during non-sampling periods or when an O2 reading is not required. This can help us determine if the sampling line needs to be blocked or isolated to protect the sample conditioning system components.

Comments or Other Pertinent Details:

Project Timing: Quote Required by:P.O. to be Issued by:	y:Equipment N	Needed on Site By:
Quete Distribution:		,
		a Quote to kep to Deliver
Optional Information:		
Miscellaneous Please answer the following guestions to help	o us serve vou better. Th	hank You!!
Do vou currently use Ntron systems?	_ □ Yes	D No
Please indicate Model No. Series or Serial No.		
Would you like information on our on-site maintenance se	vices? 🛛 Yes	
Nould you like internation on our on site maintenance set Do you use other O2 Analyzers at your plant?		
Which Manufacturar(a)?		
Which Manufacturer(S)?		
what Applications? (Ambient air, Centrifuge,		
Reactor, Vent Line, Etc.)?		
Please list other gases monitored within your		
processes at your facility.		
-		